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One-dimensional Anodic TiO$_2$ Nanotubes Coated by Atomic Layer Deposition: Towards Advanced Applications

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Abstract

Atomic layer deposition (ALD) represents a unique deposition technique that allows to coat uniformly various high aspect ratio (HAR) porous nanostructures, in addition to its traditional role to coat flat substrates (e.g. Si wafers). Self-organized anodic TiO$_2$ nanotube (TNT) layers belong among the most investigated inorganic nanostructures. They possess highly functional materials with promising application potential across many technological fields. Herein, we review the utilization of ALD for the functionalization of anodic TNT layers by secondary materials to advance their physicochemical and photoelectrochemical properties. First, the application of ALD for functionalization of porous Al$_2$O$_3$ membranes, which represent fundamental HAR nanostructure, is briefly introduced. Then the main experimental parameters governing the uniformity and the conformality of ALD coating within HAR nanostructures are discussed. Finally, the review focuses on the use of ALD to deposit secondary materials into TNT layers for various purposes — the introduction of pioneering studies is followed by particular examples of ALD based functionalizations for optimized visible-light absorption, charge separation and passivation, (photo)catalysis, stability, gas sensing, and energy storage of coated TNT layers.
Keywords
Atomic layer deposition, TiO$_2$ nanotube, coatings, functionalization, aspect ratio

Graphical abstract
1. Introduction

Titanium dioxide (TiO$_2$) represents a fascinating and highly functional material. Until now, TiO$_2$ has found its main commercial applications in pigments, food industry and cosmetics. Pioneering observation of photocatalytic decomposition of water at TiO$_2$ electrode in 1970s [1] launched the tremendous interest in the development of applications of TiO$_2$ in solar energy conversion, energy storage, and photo-assisted bioremediation, which represent essential components for the concept of renewable energy sources and of sustainable environment [2]. These applications also take the advantages of TiO$_2$ to be a low cost material with an extremely low photocorrosion rate. Additionally, thanks to inherent biocompatibility, low toxicity, and high chemical stability of TiO$_2$, emergence of biomedical applications of TiO$_2$, including photodynamic therapy for cancer treatment, drug delivery systems, cell imaging, biosensors, and genetic engineering has also taken place [3].

TiO$_2$ is a wide band gap (3.0 - 3.2 eV) n-type semiconductor and thus it absorbs light only in the UV spectral range. Generally, the material properties can be tuned by nanostructuring, realized by a gradual decrease of the characteristic size of applied materials down to the nanometer scale [4]. Nanostructuring of materials results in an extremely increased surface to volume ratio with significant impact on material physicochemical properties, including light absorption. Since many applications of TiO$_2$ are to great extent influenced by the surface of TiO$_2$ [5], nanostructuring of TiO$_2$ represent an important step for its efficient and flexible utilization in various applications.

Probably the most prominent utilization of nanostructured TiO$_2$ is represented by the utilization of TiO$_2$ nanoparticles in the dye-sensitized solar cell (DSSC), introduced by O’Regan and Grätzel [6] and by the recent utilization in perovskite solar cells [7,8]. Another class of nanostructured TiO$_2$ is presented by 1-D nanostructured materials such as nanowires, nanorods, nanobelts, and nanotubes [9]. 1-D nanomaterials share with nanoparticles (0-D materials) the high surface area and promotional size quantum confinement effects, but have one dimensions outside the nanoscale (typically pore depth of length (applies for tube, rods, wires, fibers)). 1-D nanomaterials offer better unidirectional charge/reactant/ion transport properties and better mechanical integrity. TiO$_2$ nanotube (TNT) layers prepared by anodization of Ti represent a very popular type of 1-D material with the key advantages of facile growth, self-ordering, well-controlled geometry, scalability, high
surface area, direct contact to metal-support, and suitability for coating by secondary materials [10–12]. The important characteristic parameter of TNT layers is their aspect ratio (AR), which is the ratio between length and diameter of TNT. In general, the higher AR offers the larger surface area which enhances the benefits of the nanotube structures. Another important aspect of TNT layers is their structural variability – they are amorphous in the as-anodized state, but can be converted, depending on the temperature, into anatase, rutile or their mixtures [11] with large flexibility towards applications. Last, but not least, they possess very good adhesion to the underlying Ti substrates, however, upon specific treatments, they can be detached into free-standing membranes [13,14] or nanotube powders [15].

To address complex functionalities of TNT layers in applications, it is beneficial to combine them with secondary materials. In order to keep advantages of the high surface nanotubular geometry, it is necessary to coat the entire surface of nanotubes. The most often used approaches to fill/coat the nanotube layers, such as electrodeposition [16–19], chemical bath deposition [20–22], spincoating [23,24], or sputtering [25–27], are able to uniformly coat TNTs layers with specific dimensions (predominantly with a low AR). The atomic layer deposition (ALD) represents the only deposition technique able to coat uniformly highly porous nanostructures of virtually any size [28].

ALD is an established deposition technique based on sequential self-limited adsorption of vapors of compatible precursors on surfaces leading to the formation of required coatings. The self-limited adsorption is the key aspect of ALD making it different from other deposition techniques. Under optimized conditions (temperature, pressure, and exposition time), the precursor molecules are adsorbed all over the surface in just one monolayer – further adsorption of precursor molecules on the already occupied surface sites is not allowed. No matter of the geometry of the substrate, the coatings prepared by ALD have unprecedented conformity all over the surface and their thickness is controllable on the atomic level [29]. As illustrated in Fig. 1, ALD coatings can help to tune/enhance many properties of TNT layers, such as light absorption, separation of photogenerated electron-hole pairs, photocatalytic and electrocatalytic properties, chemical, thermal, and mechanical stability, gas sensing, and energy storage. In particular, ALD is suitable for very thin coatings while it is only to a limited extent (from the point of both high precursor costs and high time demands) usable for the
growth of thick coatings (> tens of nanometers). The restricted temperature window for self-limited regime of ALD deposition and high investment costs of the tools/precursors represent main drawback of nowadays ALDs, but these are overcome step by step overcome by continuous advancements in the ALD technology and also market competition.

Recently, the usability of ALD for functional coatings of nanostructures towards energy/light-driven applications has been thoroughly reviewed [29–40]. In this review, we address the utilization of ALD to tailor the functionality of anodic TNT layers for improved performance to realize new types of devices for various purposes. First, we briefly summarize the existing literature on ALD deposition into model 1-D material – porous anodic aluminium oxide (AAO) membranes – and introduce specific theoretical features of ALD coating of HAR (HAR) nanostructures; next we focus on the utilization of ALD for functionalization of anodic TNT layers. We introduce pioneering studies of ALD into anodic TNT layers and finally we follow by the description of the utilization of ALD for improved light absorption, charge separation, (photo)catalytic properties, stability (mechanical, thermal, and chemical), gas sensing, and energy storage of ALD modified TNT layers.

Figure 1: Illustration of utilization of ALD for advanced functionalization of TNT layers

2. ALD into porous alumina membranes - Overview

Pioneering studies of utilization of ALD for functional coating of 1-D HAR nanostructures by secondary materials were performed on porous anodic aluminium oxide (AAO) membranes
— a well-established self-ordered 1-D material [41,42]. Porous AAO membranes are characterized by their mechanical, chemical, and thermal stability, nanoscale pore diameters, high surface-area ratio and low cost fabrication. These properties attracted a considerable interest for a wide number of applications in catalysis, molecular separation, electronics and photonics, (bio)sensors, energy storage and conversion, drug delivery, and templated synthesis among others reviewed by Md Jani et al. [43].

Porous AAO membranes can be fabricated via electrochemical anodization of aluminium. The application of appropriated processing parameters during the anodization (e.g. applied voltage, electrolyte concentration, etc...) allows a very good control of the pore size, the inter-pore distance, membrane thickness and AR of the pores. The inherent high surface area and AR makes porous AAO membranes particularly appealing nanoscale templates for investigations of the kinetics and mechanisms of the surface chemical reactions that the atomic layer deposition (ALD) method is based on. In particular, Fourier Transform Infrared spectroscopy (FTIR) was employed to study the binary chemical reactions to deposit SiO$_2$ and Al$_2$O$_3$ using AAO membranes as support [44–47]. ALD properties as sub-nanometer thickness control and uniformity of the deposited material into the pores were exploited in turn, to shrink the pore diameter of porous AAO membranes. The reduction of the pore diameter to molecular dimensions by the deposition of Al$_2$O$_3$, TiO$_2$ and SiO$_2$ dramatically improved the gas separation properties of the AAO membranes [48,49]. Elam et al. used ultrahigh AR (AR≈5000) AAO membranes for a comprehensive study on uniformity of ALD coating of HAR structures [50], which will be discussed in detail in the next section. ALD enables to deposit a whole range of materials into AAO as demonstrated extensively in literature. Johansson et al. first performed and demonstrated ALD of a metallic compound via the deposition of copper nanoparticles into porous AAO membranes. Therein, homogeneous particle size and particle distribution along the pores were demonstrated [51]. Following works reported on the deposition of different metals into porous AAO membranes using ALD, such as Pd [52], Ni and Co [53,54], Ru [55], Pt/Ir [56], Ag [57], and Pt [58]. Also, the deposition of sulfides [59], nitrides [60], a wide number of different oxides as Al$_2$O$_3$ [61–63], TiO$_2$ [57,62–68], Ta$_2$O$_5$ [66], Fe$_2$O$_3$ [53,54,63,69], SiO$_2$ [63,70–73], ZnO [63,74–78], SnO$_2$ [79], Co$_3$O$_4$ [80], together with heterojunctions TiO$_2$/Sb$_2$S$_3$/CuSCN(not ALD) [81] and NiO/Sb$_2$S$_3$ [82], multilayered structures as SiO$_2$/Fe$_2$O$_3$/SiO$_2$ [83,84], Fe$_3$O$_4$/ZrO$_2$/Fe$_3$O$_4$ [85], and Au−Co$_x$Fe$_{3−x}$O$_4$ core−shell
nanowires [86] have been reported. The successful utilization of ALD for build-up of functional nanostructures on AAO templates for tunable magnetism [69] and photovoltaic devices [81] is illustrated in Fig. 2.

Porous AAO membranes have served as excellent substrates to evaluate the ability of novel precursors to coat/infiltrate HAR substrates [59,70,79,80]. The ALD sub-nanometer thickness control allowed fine-tuning of pore diameters [61–63,71,72] and evaluate the impact of reduced pore diameter on the single-molecule sensing properties [61], the membrane separation properties [63,71], and the ionic transport through the nanoporous membranes [72]. The deposition of secondary materials enabled the functionalization of porous AAO membranes as different sensors [52,56,58,68], anode for Li ion batteries [67] and photoanode for dye-sensitized solar cells [74,81,82]. Except these applications, taking the unique ALD properties of conformal deposition and the wide range of materials that can be deposited, porous AAO membranes have been intensively exploited as templates for the synthesis of different nanostructures. Nanotubular structures of different nature were reported, such as TiN nanotubes (exhibiting good ductility [60]), ZnO nanotubes (with superior photoluminescence characteristics [76]), or ferromagnetic nanotubes composed of Ni and Co [53,54] and Fe$_2$O$_3$ [53,54,69] shown in Fig. 2a. Single wall TNTs [64,66] and Ag loaded TiO$_2$ nanotubes [57], wherein an enhanced photocatalytic activity compared to unloaded TNTs was revealed, and hierarchical multiwall TNTs, fabricated via deposition of alternating TiO$_2$/Al$_2$O$_3$ nanolaminates followed by wet etching of sacrificial Al$_2$O$_3$ layer [65], have been also reported. The ALD benefits were also applied for the fabrication of multilayered nanotubes, such as TiO$_2$/Sb$_2$S$_3$/CuSCN for application in solid state solar cells [81] illustrated in Fig. 2d, and SiO$_2$/Fe$_2$O$_3$/SiO$_2$ [83,84] or Fe$_3$O$_4$/ZrO$_2$/Fe$_3$O$_4$ [85], whose magnetic properties were explored and their potential applications foreseen. Porous AAO membranes also assisted the fabrication of Ru nanowire arrays as a platform for sensor devices [55] and ZnO nanorods [75,76], and ALD coated AAO membranes followed by electrodeposition enabled the fabrication of complex nanostructures as TiO$_2$-coated Ni nanowire arrays [64], Ta$_2$O$_5$-coated Ni nanorods [66], and Au-Co ferrite nanowires [86]. Likewise, porous AAO membranes have been proposed as suitable platform for different health and environmental applications - see ref. [87] and references therein. In particular,
ALD ZnO coated AAO membranes exhibited encouraging antimicrobial activity with potential dermatological applications [77,78].

Figure 2: Illustration of functional nanostructures build on templates of porous alumina membranes utilizing ALD. (a)-(c) Micrographs (SEM and TEM) of ALD deposited iron oxide nanotubes for tunable magnetic properties, adopted from [69]. (d) ALD deposited TiO$_2$ (green) and Sb$_2$S$_3$ (red) with (not ALD) CuSCN (yellow) in AAO for integration into photovoltaic device, reproduced from [81].

The utilization of ALD for coating porous AAO membranes has provided a very strong motivation case for all other high-aspect 1-D nanostructures, including nanopores [88], nanotubes [89,90], nanorods [91], nanowires [92], and branching nanostructures [93,94] of various materials, to be processed in a similar fashion. Among those, TNT layers formed by anodization maintain forefront position and promise to be treated by ALD, due to facile preparation and high functionality of TiO$_2$ compared to other materials.
3. Aspects of ALD into high aspect ratio nanostructures

In order to design an ALD process, leading to conformal coatings of HAR nanostructures, it is necessary to understand the kinetics and chemistry of that particular ALD process on the fundamental level. Numerous theoretical studies were devoted to the description of ALD surface chemistry and kinetics. A comprehensive review on theoretical aspects of ALD is beyond the scope of this review. Instead, in this section we want to focus on important theoretical aspects governing ALD in HAR nanostructures. The description of the ALD process in the HAR nanostructures was theoretically addressed by numerous models: a simple kinetic model [95], a kinetic model coupled with Langmuir adsorption [96], Monte Carlo (MC) based simulations in molecular [50, 97–102], Knudsen and diffusive [103] gas flow regimes, and numeric or analytic solutions of Boltzmann transport equation coupled with Langmuir adsorption models [104–108]. Although the studies used different theoretical frameworks, the common idea describing the parameters leading to the conformal coating of HAR nanostructures allows to draw general qualitative overview, as follows.

One of the key aspects for achieving conformal and uniform coatings is to reach the saturation regime of ALD deposition. This situation occurs when the precursor molecules fill (chemisorb on) all available adsorption positions of the substrate surface within every ALD cycle (leading to the saturation coverage). The corresponding saturating exposure dose (multiplication of saturation exposure time and pressure of precursor molecules) depends on the surface area (number of available adsorption positions [109]), the surface reaction probability (surface sticking coefficient), the diffusion rate, and the recombination loss probability (in case of plasma ALD processes) of precursor molecules. Fig. 3 illustrates the evolution of step coverage profiles of HAR nanostructure under characteristic deposition regimes of ALD discussed below. The light blue area together with arrows indicate the evolution of step coverage profile of HAR nanostructure (black area). Black dashed lines represent complete coverage profile under saturated regime of ALD.

Depending on the surface reaction probability of precursors and the aspect ratio (AR) of nanostructure, the formation of saturated coverage during ALD deposition into HAR structures can be limited either by the diffusion or the reaction ability of precursors [50]. The
so-called reaction-limited regime takes place for low surface reaction probability of precursor molecules as compared to the diffusion probability for a given AR. This corresponds to the situation when the exposure time and pressure in combination with the sufficient diffusion rate allow precursor molecules to reach every adsorption position available within the pore/trench and the only parameter governing the coverage is the surface reaction probability. The saturating exposure dose is not affected by the porous nature of substrate to be coated and nearly equals to the saturating dose for planar surfaces with the equivalent surface area [100]. The corresponding step coverage profile of the pore/trench evolves almost uniformly with increasing exposure as it is schematically illustrated in Fig. 3a. Even unsaturated coverage within one cycle of ALD can lead to the growth of uniform coatings of HAR nanostructures. This is similar to chemical vapor deposition where the conformality increases for low reaction probabilities as a result of reduced depletion of precursors along the via [110].

Figure 3: The illustration of evolution of step coverage profiles (light blue) of HAR nanostructure (black) by ALD under various process regimes. Light blue area and arrows indicate evolution of step coverage with increasing ALD exposure dose. Dashed black lines represent coverage profiles under saturated regime conditions (saturation exposure dose). (a) The reaction-limited, (b) the diffusion-limited, and (c) the recombination-limited regimes of ALD deposition.

On the other hand, the diffusion-limited regime occurs when the reaction probability (sticking coefficient) of precursor molecules is much larger than their diffusion probability to
reach bottom of an HAR nanostructure. The precursor molecules chemisorb on the available surface sites successively from the entrance-opening of the nanostructure and the precursor coverage profile evolves in the front-like manner with the increasing exposure as depicted in Fig. 3b. The saturating exposure dose approximately scales with second power of AR [50,95]. The gradient of the coverage profile within the front is step-like for reaction probability of 100% and it gradually smoothens with decreasing reaction probability [97].

In the case of plasma ALD processes, the saturation exposure dose is strongly affected by the recombination probability of the precursors, e.g. the wall recombination of plasma radicals or ozone. [100,101]. Precursor molecules rather tend to undergo recombination then to reach bottom of HAR. The coverage profiles in recombination-limited regimes are complex and not uniform, as it is drawn in Fig 3c, and the formation of saturation coverage is possible only for the limited AR with significant saturation doses [100,106,111,112].

Repeated ALD cycles (with constant exposure time) lead to the growth of thicker coating and consequently to change of characteristic dimension/radius of opening of HAR nanostructure. As a consequence, when the thickness of coating is comparable to radius of the opening of pore), the resulting thickness profile is affected as the diffusion becomes more limited. For such cases, the exposure time throughout repeated ALD cycles needs to be properly scaled in order to achieve the uniform thickness of the final coating [107].

Generally, the works introduced above show examples of set of experimental parameters governing the uniformity of ALD coating within HAR nanostructures. The determination of the sufficient saturation dose of precursor within one ALD cycle is critical for the successful ALD of uniform coatings of HAR nanostructures. In the reality, the ALD process is influenced by many experimental parameters depending on type of precursor, substrate material, ALD process parameters, and/or ALD reactor design. The results of simulation models of ALD deposition represent qualitative support for experimental determination of parameters leading to saturated regime of ALD depositions, which need to be performed and optimized for each system and coating material individually.

4. ALD into TiO₂ nanotube layers
Anodic TiO\textsubscript{2} nanotubes, prepared by the anodization of Ti, got into the forefront of 1-D nanostructured inorganic materials since the development of organic based electrolytes (such as ethylene glycol or glycerol), which allowed growth of HAR TNT layers [10,113,114]. The ability to prepare HAR TNT layers represents a key step for successful applications of TNT layers. The next important step in the development of TNT-based applications is their tailoring by secondary materials, which represents a target inherently suitable for ALD utilization.

4.1 Pioneering efforts

The first works devoted to coating of anodized TNT layers by ALD have been focused on sensitization of TNT layers by In\textsubscript{2}S\textsubscript{3} for solar energy conversion [115] and on the role of Al\textsubscript{2}O\textsubscript{3}, Ta\textsubscript{2}O\textsubscript{5}, and TiO\textsubscript{2} ALD coatings on electric properties of coated TNT layers [116].

The work of Sarkar et al. [111] presents an extensive experimental study of ALD growth of In\textsubscript{2}S\textsubscript{3} applied practically on the coating of TNT layers with AR of $\approx 62$. The ALD has been performed by utilization of Indium(III) acetylacetonate (In(acac)\textsubscript{3}) and H\textsubscript{2}S precursors. The authors performed thorough analysis of In\textsubscript{2}S\textsubscript{3} ALD process on flat substrates first. Quartz crystal microbalance (QCM), X-ray reflectivity (XRR), and FTIR were used in order to monitor mass gains during each reactant cycles, to measure the growth per cycle and its temperature dependence, to verify the self-limited surface chemistry of utilized precursors, and to identify surface species formed during sequential surface reactions. The verified ALD process parameters with increased exposure times were utilized for sensitization of HAR TNT layers by 5 nm thick In\textsubscript{2}S\textsubscript{3} ALD coating (Fig. 4a). Unfortunately, detailed SEM or TEM investigations to prove the uniformity of ALD coating of TNT layer were missing in that paper. The prominent effect of the In\textsubscript{2}S\textsubscript{3} coating on the photoelectrochemical (PEC) properties of the TNT layers is illustrated in Fig. 4b. The In\textsubscript{2}S\textsubscript{3} coated TNT layers exhibited a reduced optical band gap of 2.07 eV and reached 10 % external quantum efficiency for photon energy $>$ 2.5 eV while the uncoated TNT layer was generally photo-inactive for photon energy $<$ 3.0 eV. The observed quantum efficiency was significantly below the theoretically predicted maximum quantum efficiency ($\approx 70$ %). The limited quantum efficiency was attributed to recombination losses and charge collection/injections processes.
The work of Tupala et al. [116] presents ALD coatings of TNT layers with AR of ≈ 10 by selected metal oxides: Al₂O₃, Ta₂O₅, and TiO₂. TNT layers were prepared by anodization of Ti thin layers evaporated on ITO conductive glass. The TNT layers prepared on transparent conductive support are a very suitable material for solar energy applications (e.g. perovskite solar cells [8]) and their functionalization is an important technological step. The ALD was performed with established precursors: trimethylaluminium (TMA, Al(CH₃)₃), tantalum pentoxide (Ta(OEt)₅), and titanium tetraisopropoxide (Ti(OiPr)₄) in combination with water. The target thickness of the coating was 5 nm. The example of TiO₂ coated TNT layers is shown in Fig. 4c. TNT layers coated by ALD were shown to have higher electric conductivities (across the layer) compared to their uncoated counterparts, as shown in Fig. 4d.
Figure 4: Pioneering ALD coatings of TNT layers. (a) The In$_2$S$_3$ coating of TNT layers and (b) corresponding quantum efficiency. (c) The TiO$_2$ coated TNT layer and (d) the current density through the TNT layer modified by various metal oxide coatings. (a) and (b) were reproduced from [115] and (c) and (d) were reproduced from [116].
Despite both these pioneering works clearly demonstrated the functionality of ALD coated TNT layers, they did not provide any direct evidence of uniformity of ALD coatings within the TNT layers (such as SEM and TEM images). The follow up work of Macak et al. [117] presented interestingly improved light trapping properties of plasma ALD In$_2$O$_3$ coated TNT layers with AR up to ≈ 80 together with microscopic evidence of the presence of the In$_2$O$_3$ coating. The ALD deposited In$_2$O$_3$ was found to successfully coat the entire TNT interiors with gradually decreasing thickness of the coating from 30 to 5 nm from top to the bottom of the TNT layer (with AR ≈ 80, and layer thickness of ≈ 8 µm), respectively. The observed thickness gradient of In$_2$O$_3$ resulted from a limitation of plasma assisted ALD to coat uniformly HAR nanostructures due to the limited lifetime of plasma-generated radicals and recombination effects.

Contrary, utilizing the thermal ALD process, Zazpe et al. [118] reported uniform ALD deposition of Al$_2$O$_3$ coatings within TNT layers with a high AR of ≈ 180. The conformality of ALD Al$_2$O$_3$ coatings with various exposure times of TMA precursor was inspected by SEM at different depth levels of the TNT layers (and supported by in situ QCM measurements and STEM investigations). With an increasing exposure time of TMA, the ALD coating was found to be uniform down to the deepest levels of TNT layers, as shown in Fig. 5a. Optimal exposure time led to uniform coatings within the entire TNT layers, as demonstrated by SEM images measured at four different depth levels of the coated TNT layers, shown in Fig. 5b-e. The observed results correspond to diffusion limited regime of ALD growth, as introduced in [50] and discussed in the previous section.

These pioneering works present the successful utilization of ALD for coating of TNT layers by secondary materials with advanced functionalities, relevant for solar energy conversion and other optoelectronic applications. Obtained results clearly demonstrate that the ultra-thin ALD coating is able to significantly alter the functionality of TNT layers and prove that ALD is the most suitable and practical technique to tailor properties of HAR nanostructures.
Figure 5: ALD Al$_2$O$_3$ coating of TNT layers with aspect ratio of 180: (a) Influence of exposure time of TMA precursor during one ALD cycle on uniformity of thickness of Al$_2$O$_3$ coating within TNT layer; (b-e) Illustration of uniform thickness of Al$_2$O$_3$ coating for 5s TMA exposure time as revealed by SEM inspection through four different depth levels—top, near-top, middle, and bottom, respectively. Reproduced from [118].

Table 1 presents a complete list of reports utilizing ALD for coating HAR anodic TNT layers. In the following text, these reports will be introduced in thematically selected sections, as illustrated in Fig. 1.
Table 1: Summary of ALD coatings on TNT layers together with the information about geometry of TNT layers (* difference between inner and outer tube diameter taken into account).

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<th>Material</th>
<th>Year</th>
<th>L (µm)</th>
<th>D (nm)</th>
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<th>Ref</th>
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<td>65</td>
<td>62</td>
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<td>120</td>
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L = tube length, D = inner tube diameter
4.2 Light absorption and photoelectrochemical conversion

While the TiO$_2$ efficiently absorbs light in the UV spectral range, the main limitation for solar-light-driven applications of TiO$_2$ is its relatively large intrinsic band gap (3.2 eV for anatase and 3.0 eV for rutile) which does not allow light absorption within the visible-light spectral range. Besides a dye sensitization [119] or a metal/non-metal doping [120–124], an alternative way to improve visible-light photoelectrochemical (PEC) performance of TiO$_2$ is the modification of TiO$_2$ by a suitable narrow band gap semiconductor. The photoexcitation connected with the effective charge separation leading to the electron injection to the TiO$_2$ conduction band can significantly enhance the visible-light photoresponse of TiO$_2$ based heterostructures, such as nanoparticulate and nanotubular layers. In order to absorb most of the incident light, the range of thicknesses of the compact absorber layers should be on the microscale. Thus, the ALD does not qualify itself as most suitable deposition technique at first glance for this purpose, since it is technique suitable for production of coatings with thickness on the nanometer scale. However, the situation is diametrically different in the case when HAR nanostructures are used as substrates. Only a few tens of nm thick absorber layer (or even less) are effective enough for efficient solar energy harvesting, as a result of tremendously increased specific surface area of the HAR nanostructure, allowing to reach the effective absorption mass of sensitizer with comparably thinner coatings than for planar substrates, and the multiple light scattering events, prolonging significantly optical path in HAR nanomaterials [125–127]. Moreover, a low thickness of absorber layer is also critical for the reduction of charge recombination losses during charge transfer through the material. The length-scale of effective charge separation is characterized by the size of the depletion layer. On the nanometer scale, the ALD serves as an excellent tool for deposition of uniform coatings with minimum amount of defects, which represents fundamental building block for highly efficient TiO$_2$ nanomaterials to be used for solar energy conversion applications.

The first work utilizing ALD to coat TNT layers by secondary visible-light absorbing material was carried out by Sarkar et al. [115], as discussed in the previous section. The following work was performed by Huang et al. [128], who deposited Co$_3$O$_4$ into TNT layers with AR over 100. The ALD was performed utilizing Bis(cyclopentadienyl)cobalt(II) (Co(Cp)$_2$) and O$_3$ as ALD precursors. The thickness of the coating was ranging up to 20 nm and it was verified by SEM and by the calibration on reference Si wafer. ALD Co$_3$O$_4$ coated TNT layers were
explored for the visible-light (>420 nm) induced photocurrent generation. The best photocurrent response was observed for TNT layers coated by Co$_3$O$_4$ with a thickness of 4 nm. The corresponding PEC performances of the 4 nm ALD Co$_3$O$_4$/TNT layer, a reference Co$_3$O$_4$/TNT layer coated by impregnation method, and a reference blank TNT layer are shown in Fig. 6a,b. The enhanced PEC performance of ALD Co$_3$O$_4$/TNT layers was attributed to the favourable band alignment of Co$_3$O$_4$/TNT layers as revealed by XPS, shown in Fig. 6c, and to the ALD technique used, providing uniform Co$_3$O$_4$ coating of controlled thickness and with minimal amount of defects, which maintained the large open surface area of TNT layers and minimized charge recombination losses. However, it is worth to note that the reported absolute values of the photoconversion efficiency (Fig. 6b) were extremely low.

A significantly pronounced positive effect on the visible-light photoresponse can be expected, when CdS is utilized as a light absorber with TiO$_2$ [129]. CdS is predominantly deposited in the form of quantum dots (QD) by conventional techniques such as chemical bath deposition [20,130], successive ionic layer adsorption (SILAR) [21,131], or electrodeposition [132], which can generally provide decoration of HAR nanostructures with much more limited uniformity than ALD. The expected efficiency of CdS sensitized TNT layers scales with the total surface area of TNT layer as long as the TNT layer can be uniformly coated by sensitizer (and diffusion length of charge carriers is long enough to reach collecting electrodes [133]). A direct way to increase surface area (AR) of TNT layers is (i) to decrease the diameter of nanotubes (increase their areal density) or (ii) to increase the overall thickness of TNT layers. The next two works well describe cases (i) and (ii)
Figure 6: PEC performance of 4 nm thick $\text{Co}_3\text{O}_4$ coating of TNT layers by ALD. (a) The photocurrent density and (b) photoconversion efficiency of $\text{Co}_3\text{O}_4$/TNT layer heterostructure upon visible-light illumination (> 420 nm, 100 mW/cm$^2$). (c) Illustration of band alignment within the heterostructure as determined by XPS. Reproduced from [128].

Krbal et al. [134] reported downscaling the tube diameter of ALD CdS sensitized TNT layers for efficient PEC energy conversion. TNT layers with thickness of 600 nm and with different average tube diameters of 35, 56, and 96 nm — featuring various surface areas (52, 29, and 23 cm$^2$/cm$^2$, respectively) — were coated by 6 nm thick CdS layers by ALD (using Dimethylcadmium and H$_2$S as precursors). The corresponding morphology of CdS coated TNT
layers with various tube diameters, captured by SEM, is shown in Fig. 7a-c. The obtained incident photon to conversion efficiencies (IPCE) are shown in Fig. 7d, respectively. The CdS coating of TNT layers led to the strong enhancement of their photoresponse in the visible-light spectral range. The photoresponse rose with the decreasing TNT layer tube diameter (increasing surface area). The composite ALD CdS/TNT layer with the smallest tube diameter ≈ 35 nm (largest surface area ≈ 52 cm$^2$/cm$^2$) exhibited IPCE above 50% up to 470 nm with the photoresponse onset around 520 nm (corresponding with the band gap of CdS ≈ 2.4 eV).

In a follow up study, Zazpe et al. [125] presented on the upscaling of the thickness of ALD CdS coated TNT layers. Ultra HAR TNT layers with thicknesses between 1 µm and 130 µm (AR up to 900) were coated by ALD CdS with thicknesses between 2 nm and 10 nm. The evidence of 10 nm CdS coating of a fraction of TNT layer featured by HAADF STEM image and STEM/EDX elemental mapping with corresponding line profiles is depicted in Fig. 7e-g, respectively. The utilization of CdS coated ultra HAR TNT layers resulted first of all into a superior PEC performance, as demonstrated by high IPCE values of around 70%. In addition, it resulted in an apparent shift of the onset of visible-light photoresponse of CdS-TNT layers up to 675 nm (≈ 1.8 eV, significantly below the band gap of CdS) while the IPCE around 70% was kept in the range from 300 to 600 nm, as it is shown in Fig. 7h. The unexpectedly significant shift of the onset of photoresponse was attributed to the advantageous geometry of the ultra HAR TNT layers giving rise to multiple light-scattering effects, which extremely prolong the optical path of light within nanostructure as illustrated in Fig. 7i and therefore enhances the probability of capturing light by sub-band gap transitions in conformal and uniform ALD CdS coatings. The obtained results clearly demonstrate the profitability of ALD for light harvesting applications to effectively utilize the deposited material in form of a uniform ultrathin coating, perfectly adopting a large surface/interface area of the support nanostructure, using TNT layer as a model example.
Figure 7: ALD coating of TNT layers by CdS light-absorber layer for improved visible-light photoresponse. (a-c) SEM images of 6 nm CdS coated TNT layers with average tube diameters 35 nm, 56 nm, and 95 nm, respectively, scale bar 100 nm. (d) IPCE of TNT layers with various nanotube diameter sensitized by 6 nm thick ALD CdS coating upon illumination with a monochromatized light source (e) High angle annular dark field (HAADF) STEM image and (f) STEM/EDX elemental map of fraction of nanotube coated by 10 nm thick CdS overlayer, the green arrows mark the corresponding elemental line profiles shown in (g). (h) IPCE of TNT layers with various thicknesses sensitized by 5 nm thick ALD CdS coating. (i) Illustration of multiple light scattering effects prolonging the optical path of light in TNT layer and facilitating efficient light harvesting. (a-d) Reproduced from [134] and (e-i) reproduced from [125].

The improved photoresponse of ALD coated TNT layers was also presented by Ng et al. [135], who deposited molybdenum oxyselenide (MoSe$_x$O$_y$) coating utilizing Mo(CO)$_6$ and (CH$_3$Si)$_2$Se ALD precursors. The optimal thickness of the MoSe$_x$O$_y$ coating for maximal photocurrent generation and photocatalytic degradation of model dye (methylene
blue(MB)) was found to be within the range of 2 – 5 nm. The study represents a fundamental step for future tailored deposition of transition metal dichalcogenides, such as MoSe\textsubscript{2} [136], into TNT layers by ALD.

4.3 Charge separation

Generally, one of the key limiting factors of the performance of solar cell devices is the recombination of photogenerated charge carriers. Main charge recombination centres are represented by defects, trap states and charge impurities at surfaces and interfaces, e.g. Ti\textsuperscript{3+} interstitials giving rise to Ti 3d states below conduction band edge in TiO\textsubscript{2} [137,138]. For HAR nanostructures (which are also high surface area materials), the prevention of recombination at surfaces/interfaces is of utmost importance. One way to suppress the recombination on surface defects is to prepare surfaces with lowest possible concentration of surface defects. This can be realized either by optimization of the growth conditions of that particular material itself or by deposition of an overlayer of a suitable defect-depleted material — passivation layer — which passivates the surface defects of an underlying material. However, such an overlayer should not alter the properties of the underlying material and should be very thin not to limit the charge transfer through the layer itself. The charge recombination at the interfaces can be suppressed by a combination of compatible materials, forming a high quality interface with low amount of defects and with an inherent energy barrier for the back transfer of electrons or holes. ALD, being inherently ideal for the deposition of conformal and uniform coatings with minimal amount of defects and thickness controlled on the nanometer scale, represents very promising technique for the growth of blocking/passivating layers.

The credit of ALD is reflected by a high number of recent studies utilizing ALD for deposition of blocking layers. For the case of TNT layers, the ALD was utilized for the deposition of Al\textsubscript{2}O\textsubscript{3} [139–142], ZnO [142–148], and TiO\textsubscript{2} [142,149] thin coatings as blocking layers in order to improve the PEC performance of TNT layers. In addition, the same materials were also utilized as blocking layers in mesoporous TiO\textsubscript{2} layers used in DSSC [150–154].

Wide band gap and almost ideal ALD growth make Al\textsubscript{2}O\textsubscript{3} a prototypical material for a blocking layer deposited by ALD. ALD growth of Al\textsubscript{2}O\textsubscript{3} is usually realized using TMA and
water as precursors. Gui et al. [140] coated TNT layers by Al₂O₃ by 10 - 200 ALD cycles at 100 – 400 °C temperature range in order to enhance the PEC water splitting by the surface passivation of TNT layers. The best PEC performance was observed for Al₂O₃ coating by 25 cycles (2.6 nm) at 200 °C yielding 1.8 times higher photocurrent density than bare TNT layers. Kim et al. [139] coated TNT layers with AR of ≈ 230 by ultrathin Al₂O₃ coatings with thickness of 0.1 – 0.6 nm (deposited by 1 - 6 ALD cycles) at 200 °C and subsequently sensitized them with N-719 ruthenium based dye. The study showed that already after one ALD cycle, the Al₂O₃ coating led to an increase of open circuit voltage and prolonged the electron life times. In contrast, Al₂O₃ coatings deposited by more than two ALD cycles was found to reduce the photocurrent density as a result of an increase of the energy barrier for the injection of electrons from the dye to the TiO₂ conduction band. Zeng et al. [141] examined the role of ALD Al₂O₃ overlayers with various thicknesses on PEC performance of coated CdS and PbS QD sensitized TNT layers. The Al₂O₃ overlayers were deposited by 3 – 100 ALD cycles. The optimal thickness leading to improved charge collection efficiency was found to be 1.5 nm (achieved by 30 ALD cycles) yielding 1.6 times higher photocurrent density than for bare QD sensitized TNT layers. For the illustration of properties of Al₂O₃ ALD coating of TNT layers, the structure of 30 ALD cycles Al₂O₃ coated QD-TNT layers and PEC efficiency with model of beneficial interface band alignment of ALD Al₂O₃ coated QD-TNT layers are shown in Fig. 8a-c.

Fundamental mechanisms behind the passivation effect of Al₂O₃ overlayers can be learned from the field of silicon solar cells [155]. Al₂O₃ coatings help to reduce the surface/interface recombination rate by (i) passivation of surface/interface defects, so-called chemical passivation which is realized by hydrogen incorporated naturally in bulk Al₂O₃ [156] and (ii) by significant reduction of the concentration of one type of charge carrier at the surface/interface by an electric field denoted as field effect passivation, that stems from the inherent accumulation of negative charge in Al₂O₃ near the interface, connected to defects in form of Al vacancies and O interstitials [157]. The higher is the temperature of ALD process, the lower amount of hydrogen is found in Al₂O₃, resulting in less effective chemical passivation [158]. The optimal temperature range for Al₂O₃ ALD deposition is found to be between 150 and 250°C. The post-deposition annealing of Al₂O₃ improves the passivation effect with onset above 300 °C as it promotes diffusion of H towards the interface and also
increases the negative charge accumulated in Al$_2$O$_3$. The thickness also affects the passivation capability of Al$_2$O$_3$. The chemical passivation starts to be limited for coatings thinner than 5 nm, while the field effect passivation remains down to 2 nm. On the other hand, increased thickness of the passivation layer limits its charge transfer properties. The trade-off between the passivation and charge transfer properties yields optimal Al$_2$O$_3$ thicknesses of around 2 nm employed as capping passivation layer [ref?]. The above discussed results clearly demonstrate the uniqueness of ALD to tailor the coatings of HAR nanostructures on atomic level and ultrahigh precision, non-feasible for alternative deposition techniques.

In an analogous way to Al$_2$O$_3$, several works addressed to which extent the PEC performance of TNT layers based photoanodes can benefit from the secondary coating by thin ZnO overlayer, deposited by ALD. ZnO represents a direct band gap semiconductor with the band gap value (3.4 eV) close to TiO$_2$, which is known to promote efficiency of DSSC [159]. Jeong et al. [143] coated TNT layers by 10 nm thick ZnO (using 50 ALD cycles) and sensitized it by N719 dye. The ZnO coating was found to form a particulate-like decoration of TNT layers increasing the surface area of the photoanode. The short circuit photocurrent density improved from 3.98 to 4.31 mA/cm$^2$. Correspondingly, the efficiency improved from 1.23 to 1.42% by ZnO coating. The positive effect of the ZnO coating was attributed to the increased surface area of ZnO coated TNT layers and to the high isoelectric point of ZnO forming an inherently positive charge at the ZnO/electrolyte interface, facilitating an efficient dye adsorption. Moreover, the difference of TiO$_2$ and ZnO isoelectric points caused a negative shift of the TiO$_2$ conduction band, resulting in an increased energy level difference with the liquid electrolyte leading to an increased open circuit voltage.

In several studies, Cai et al. [144,145,147,148] inspected the effect of 2, 5, and 10 nm thick ZnO coating (deposited by 10, 25, and 50 ALD cycles) on the PEC performance of ZnO/TNT layers and of functionalized poly(3-hexylthiophene)/ZnO/TNT layers. The best PEC performance was revealed for 2 nm thick ZnO film (10 ALD cycles). The photocurrent density rose by a factor of 1.6 and the results of impedance spectroscopy pointed to the improved charge separation featured by lowered charge-transfer resistance, negative shift of flat band potential, and longer electron lifetimes. The additionally Poly(3-hexylthiophene) functionalized ZnO/TNT layers showed increased light absorption and promoted
photoluminescence quenching as a mark of suppressed radiative recombination of photogenerated charge carriers [148].

Zeng et al. [146] deposited a thin ZnO layer by ALD as an interlayer for PbS and CdS QD sensitised TNT layers. The authors utilized TNT layers with various thicknesses (1.5 – 2.8 µm) and coated them by ALD ZnO with thickness between 0.7 and 10.5 nm (5, 10, 30, and 70 ZnO ALD cycles). The ALD ZnO/TNT layers were afterwards loaded by CdS/PbS QD using SILAR technique. Illustrative SEM and TEM images of TNT layer coated by ALD ZnO (30 ALD cycles equivalent to thickness of 4.5 nm) and decorated by PbS/CdS QD are shown in Fig. 8d,e. The observed increase of the light absorption and the PEC performance after ZnO coating was most pronounced for the 2.4 µm thick TNT layers with CdS/PbS QD loaded over coating of 10 ALD cycles of ZnO (1.5 nm thick) resulting in the maximum photoconversion efficiency of 4.6% at -0.6 V (1.3-fold increase compared to uncoated PbS/CdS QD sensitized TNT layers), as shown in Fig. 8f. The positive effect of ZnO interlayer was rather attributed to the increased amount of QD formed on ZnO modified TNT layers, than to effective passivation/blocking properties of ZnO coating. The ZnO coating itself was not found to alter the PEC properties of TNT layers. This was attributed to the amorphous structure of ZnO coatings leading to significant recombination of photogenerated charge carriers.

Generally, ZnO is considered as an attractive material for the coating of photoanodes because of its high electron mobility, which is at least an order of magnitude higher than in TiO$_2$ [160]. However, the high electron mobility in ZnO is also accompanied by a high recombination rate of charge carriers, limiting the overall PEC performance of any potential application. Contrary to Al$_2$O$_3$, neither the direct evidence of passivation effect of ZnO overlayers, nor the underlying fundamental process in a strict sense of chemical or field effect passivation have been introduced for ZnO coatings of TNT layers. The pronounced effects of ZnO coatings on PEC performance can be attributed to a higher uptake of dye molecules, higher electron mobility, and an increase of the open circuit voltage due to staggered band alignment in ZnO/TiO$_2$ heterostructures [142–148]. ZnO features itself rather as an electron transport layer, which can in combination with TiO$_2$ boost electron transport properties, rather than a typical blocking layer forming an energy barrier suppressing the charge recombination.
One of the key attributes of ALD is the deposition of high quality thin films with low concentration of defect sites and absence of pinholes. Therefore, it can be beneficial to coat TiO$_2$ nanostructures by additional ALD TiO$_2$ coatings. TiO$_2$ ALD coating of TiO$_2$ nanowires and nanorods leads to significantly improved PEC performance attributed to improved charge collection efficiency by passivation of defect sites and increased surface area [161,162]. Anodized TNT layers produced in ethylene glycol based electrolytes are known to form a double wall structure with a porous inner wall rich on carbon and Ti-oxihydroxide species, which limit the electron transport properties [14,163]. The removal of the inner wall improves the carrier transport [164], photocatalytic [165], and PEC properties of the TNT layers [166] and leads to a better performance of TNT layers in DSSC [147]. However, it requires the double wall TNT layers to be etched in piranha solution to remove the inner wall. Another approach is to coat the double wall TNT layers with TiO$_2$ by ALD. Sopha et al. [149] presented enhanced PEC performance of anodized TNT layers coated by ALD TiO$_2$ overlayers with various thickness ranging from 3 to 22 nm (50 to 400 ALD cycles). The PEC performance of ALD TiO$_2$ coated TNT layers was compared to blank TNT layers and TNT layers decorated with TiO$_2$ nanoparticles deposited from TiCl$_4$ solution. The obtained IPCE and photocatalytic degradation of a model dye (MB) are shown in Fig. 8g,h, respectively. The presence of the coating led to an increase of the photocurrent density and more effective dye decomposition. The coating with optimal thickness, corresponding to 11 nm (200 ALD cycles), displayed two fold increase of photocurrent density over blank TNTs layers, 1.5 times higher photocurrent density than nanoparticle decorated TNT layers, and 3.5 times higher rate constant for MB decomposition. Moreover, a significantly decreased amount of trap states in TiO$_2$ as a results of ALD TiO$_2$ coating of TNT layers was stressed out by a significantly faster photocurrent response in the photocurrent transients for TiO$_2$ coated TNT layers in comparison to uncoated ones. These data were corroborated with Mott-Schottky measurements showing lower majority charge carrier concentration pointing to decreased defect and oxygen vacancy concentrations in ALD TiO$_2$ coatings. Thicker TiO$_2$ coatings led to partial clogging of tube interiors and to a decrease of the active surface area and hence lower PEC activity.
Figure 8: ALD deposited surface passivation layers for enhanced charge separation. (a) Representative TEM image, (b) observed PEC efficiency, and (c) model of interface band alignment of ALD Al₂O₃ passivated QD sensitized TNT layers, adopted from [141]. (d) SEM top view, (e) TEM side view, and (f) PEC efficiency of ALD ZnO coated QD sensitized TNT layers, reproduced from [146]. (g) IPCE and (h) rate of photocatalytic decomposition of model dye by ALD TiO₂ passivated TNT layers, reproduced from [149].

Zhou et al. in 2017 [142] performed a cross comparison of the effect of 1.5 nm thick TiO₂, ZnO, and Al₂O₃ passivation ALD coatings on PEC performance of PbS/CdS QD sensitized (using SILAR) TNT layers. The maximal photocurrent densities were found to be 4.3, 5.0, 5.6 mA/cm² for TiO₂, ZnO, and Al₂O₃ overlayers, respectively. In line with previous work [141],
the coating by Al$_2$O$_3$ was found to be able (i) to increase the charge carrier concentration by passivation of surface trap sites and (ii) to improve the charge transfer efficiency in the bulk and at the interface while the ZnO and TiO$_2$ coatings were found only to improve the charge transfer efficiency.

4.4 Photocatalysis and electrocatalysis

TiO$_2$ represents one of the important building blocks for advanced catalytic materials for fuel and chemicals processing, hydrogen economy, and water/environmental remediation processes [167]. Photocatalytic and electrocatalytic applications of anodic TNT layers benefit from high surface area, improved charge separation and efficient charge transfer properties of TNT layers [168]. Another important aspect is also that the anodic TNT layers are inherently firmly attached to the metal Ti support, giving lots of advantages. As compared with nanoparticles, there is no immobilization pre-treatment or separation post-treatment needed for direct catalytic applications of anodic TNT layers. In order to develop even more effective TNT layer-based photocatalysts or electrocatalysts, it is of advantage to combine TNT layers with functional secondary materials in the form of compact coatings or nanoparticles [169–174]. As emphasized earlier in the text, ALD represents an ideal technique for coating of HAR nanostructures featuring high uniformity, low amount of defects, and a high degree of control over deposition rate. For the photocatalytic applications based on TNT layers, it is important to stimulate visible-light photoresponse, facilitate adsorption of reactants and desorption of products, and improve charge transfer to reactants. For the electrocatalytic applications, the TiO$_2$ plays the role of the metal oxide support facilitating good particle dispersion all around the surface and promoting the stability of metal particle catalysts [174].

The first work employing ALD for promoting photocatalytic properties of TNTs layers was introduced by Turkevych et al. [175]. The authors explored the synergistic effect between TiO$_2$ and metal oxide/sub-oxide/mixed-oxide nanoclusters on the photocatalytic decomposition of MB under simulated solar light. TNT layers with a thickness of 7.5 µm and tube diameters of 95 nm were loaded by Al$_2$O$_3$, SnO$_2$, TiO$_2$, ZnO, CuO, and WO$_3$ (employing water as the oxidant, total 6 ALD cycles), their sub-oxides (employing atomic hydrogen, total 3 ALD cycles), and mixed oxides. Resulting rate constants of MB decomposition for ALD
functionalized TNT layers (relative to the bare TNT layer and compared to TNT layers functionalized by chemical bath deposition (CBD)) are shown in Fig. 9a. Modification of TNT layers by stoichiometric metal oxides did not lead to an increase of the photoresponse, while for the metal suboxides and mixed oxides the significant synergy led to an increased photoresponse. The positive effect on the visible-light absorption was attributed to the upward shift of the valence band of TiO$_2$ (without an effect on the conduction band) near the surface induced by the presence of suboxide/mixed oxide clusters, featuring low valence states [176] and metal-to-metal bonds at non-stoichiometric interfaces between agglomerated suboxide/mixed oxide nanoparticles [177].

Another possibility to prepare catalytically active TNT layers is to decorate them with noble metal nanoparticles. Assaud et al. [172] deposited Pd nanoparticles by ALD into TNT layers for electrooxidation of ethanol (EOR). ALD was employed to allow a precise control over the deposition rate of Pd and to provide uniform size distribution of particles over the entire TNT layer surface. Various Pd nanoparticles with sizes from 6.5 to 25 nm (400 – 900 ALD cycles) were deposited on as-anodized (amorphous) and annealed (450 °C, anatase) 1 µm thick TNT layers with a tube diameter of 70 nm, which were anodized in an aqueous F$^-$ electrolyte. Cyclic voltammetry and chronoamperometry revealed the best electrocatalytic performance and satisfactory stability for Pd nanoparticles with an average size of 7 nm (500 ALD cycles) deposited within annealed TNT layers. Negligible electroactivity of smaller Pd particles was attributed to strong metal-support interaction [178], resulting in burying of Pd nanoparticles into the TiO$_2$ support and their deactivation. On the other hand, lower electroactivity of larger Pd particles was attributed to very weak metal support interaction and a decreased surface area. Annealing of TNT layers was found to stabilize Pd in the metallic state (the active form for the ethanol electroxidation) and to increase the electron conductivity.

Follow up work of Barr et al. [179] studies the effect of ALD coated SnO$_2$ TNT layers as a support loaded by ALD deposited Pd nanoparticles on the electroactivity for EOR. ALD was first utilized for coating TNT layers with SnO$_2$ as a support for later ALD deposition of Pd nanoparticles. It is worth to note that the nucleation period of the Pd ALD growth on ALD SnO$_2$ modified TNT layers (less than 100 cycles) was found to be comparably lower than on bare TNT layers (400 ALD cycles), as a result of strong reduction of SnO$_2$ surface during Pd deposition by ALD. The morphology of the Pd/SnO$_2$/TNT composite structure is illustrated
schematically in Fig. 9b. The TEM image reveals structure of ALD 6.5 nm Pd nanoparticles/ALD 14 nm (annealed) SnO$_2$/TNT layer, which displayed the best electrocatalytic activity for EOR, as depicted in Fig. 9c. The promotional effect of SnO$_2$ on catalytic activity of Pd nanoparticles was attributed to (i) facilitated OH adsorption on SnO$_2$, (ii) favourable Pd nucleation and ALD growth on SnO$_2$, (iii) higher electrical conductivity of annealed SnO$_2$, and (iv) metal-support interaction.

Photocatalytic generation of hydrogen by ALD Pt loaded TNT layers was demonstrated by Yoo et al. [173]. Single walled TNT layers [163] were exposed to different number of Pt ALD cycles (8 – 72 cycles) leading to the growth of Pt nanoparticles with diameter of 2 – 15 nm. The morphology of bare and Pt-TNT layers loaded by 40 ALD cycles is shown in Fig. 9d, where the homogeneous coating of nanotube’s bottoms by uniform Pt nanoparticles (11 nm) is evident. Photocatalytic generation of hydrogen by Pt-TNT layers with different Pt loading upon illumination by UV laser (235 nm) and solar simulated light is shown in Fig. 9e. Pt plays the role of the co-catalyst enabling efficient electron transfer at the catalyst/environment interface. The best performance is observed for Pt particles with a size of 7 nm (26 cycles, highest areal density) and 11 nm (40 cycles) for simulated solar light and UV illumination, respectively. The difference of these maxima is attributed to the light penetration depth, i.e. result of a trade-off between the positive effect of Pt loading and the negative effect caused by shading of TiO$_2$ support.

Another utilization of ALD Pt nanoparticles modified TNT layers for electrocatalytic methanol oxidation was reported by Anitha et al. [174]. Methanol oxidation reaction is crucial for the operation of the anode side of direct methanol fuel cells [180]. TNT layers with different thicknesses (1, 5, and 20 µm) were coated by Pt particles with average diameters ranging from 1.3 to 4.6 nm (and continuous Pt film). The best electrocatalytic performance (showing 74 mA/cm$^2$ anodic current density with superior time stability) was reported for 20 µm thick TNT layers decorated by Pt particles with average size 4.6 nm (88 ALD cycles). The obtained results were outperforming the classical substrates used for electrocatalysis, such as graphite or carbon Pt black. The high electrocatalytic activity was attributed to the Pt-TiO$_2$ metal-support interaction, preventing CO poisoning of Pt particles and the effective utilization of high surface area of TNT layers as a support for homogeneously distributed active Pt nanoparticles provided by ALD.
Figure 9: ALD functionalized TNT layers for photocatalytic and electrocatalytic applications.

(a) Relative rate constants of methylene blue decomposition on TNT layers coated by various ALD and CBD deposited metal oxides/suboxides/mixed oxides, reproduced from [175]. (b) TEM image of ALD Pd nanoparticles on a ALD SnO$_2$ coated TNT layer for ethanol electrooxidation, composite nanostructure is illustrated schematically in the inset. (c) Linear sweep voltammetry and photocurrent density at -0.2 V (inset) for 500 cycles Pd on as-grown TNTs, annealed TNTs, as-grown SnO$_2$/TNTs, and annealed SnO$_2$/TNTs in 1 M KOH + 1 M C$_2$H$_5$OH, scan rate 25 mV/s. (b) and (c) were reproduced from [179]. (d) SEM picture of bare and 40 ALD cycles coated TNT and (e) corresponding dependence of photocatalytic H$_2$
4.5 Stability and improved physical properties

In addition to the enhanced charge carrier separation, light absorption and (photo)catalytic properties discussed above, ALD coating of TNT layers by secondary materials brings also the possibility to improve mechanical, thermal, and chemical stability of TNT layers. Enhanced mechanical stability of TNT layers can, for instance, help to boost applications of modified TNT layers as flow-through membranes for photocatalysis [13] or those, where some wear (friction) can be expected. On the other hand, the thermal and chemical stability are important for utilization of TNT layers for catalytic and gas sensing applications at elevated temperatures and in harsh acidic environments (ambient humidity).

Positive effects of ALD Al\(_2\)O\(_3\) coatings (1 – 42 nm thick) on the stability of TNT layers were reported by Zazpe et al. [181]. Therein, ALD Al\(_2\)O\(_3\) coatings as thin as 1 nm led to an increased thermal stability of the TNT layers up to 870 °C in air (nanotubular structure was preserved) and provided extremely good chemical stability of TNT layers in strongly acidic environments (solution of H\(_3\)PO\(_4\) at 60 °C), while the bare TNT layers collapsed, as depicted in Fig. 10a-d. The Al\(_2\)O\(_3\) overlayer was found to help to maintain the TiO\(_2\) anatase crystal structure (more favourable for electron transfer) over wider range of temperatures, blocking the conversion to TiO\(_2\) rutile as a result of hindered oxygen diffusion through Al\(_2\)O\(_3\) coating. Moreover, Al\(_2\)O\(_3\) coating of TNT layers improved the mechanical integrity of TNT layers, as determined by nanoindentation measurements depicted in Fig. 10e, respectively. In the already discussed work of Zeng et al. [141], 1.5 nm thick ALD Al\(_2\)O\(_3\) coating was found to effectively retard the photocorrosion of chalcogenide QD used as a sensitizer of TNT layers, as it is illustrated on photocurrent decay in Fig. 10f.
Figure 10: Improved stability of TNT layers coated by ALD Al₂O₃. (a) As prepared bare anodic TNT layer which (b) collapsed as a result of annealing at 870 °C in air. (c) Preserved structure of 1 nm thick ALD Al₂O₃ coated TNT layer upon annealing at 870°C and (d) soaking in a solution of H₃PO₄ (85 wt %, 60 °C, 8 hours), size of scale bar is 100 nm (representative for all SEM images). (e) Improved mechanical integrity of ALD Al₂O₃ coated TNT layer. (a-e) reproduced from [181]. (f) Higher resistivity of QD sensitized TNT layer to photocorrosion as a result of surface passivation by 1.5 nm thick ALD Al₂O₃ layer, reprinted from [141].

4.6 Gas Sensing

TNT layers as a 1-D material with a high surface to volume ratio represent promising nanostructures for the utilization in gas sensors [182,183]. 1-D nanostructures are suitable for conductometric gas sensors, which are based on the change of resistivity with the adsorption of target-detection gases. The adsorption of gas influences the conductivity only in the near surface region and therefore for high response/low detection limit it is necessary to build gas sensors with maximal surface to volume ratio. The best sensitivity can be achieved, if the size of the gas sensing nanostructure is constrained to the size of the charge depletion layer (typically tens of nanometers). The high quality uniform coatings produced by ALD in HAR nanostructures (TNT layers), with thicknesses adjustable on the nanometer
scale, represent an excellent way to tailor the sensitivity and selectivity of 1-D nanostructured (TNT layers-based) gas sensors [184].

Ng et al. reported a successful utilization of ALD for modification of TNT layers by thin ZnO coatings for ethanol sensing [185]. TNT layers were coated by ZnO overlayers with thicknesses ranging from 0.2 to 19 nm. Interestingly, the ZnO coatings were shown to increase the photoresponse of TNTs layers in the UV spectral range and to extend it towards visible spectral range, as illustrated in Fig. 11a. The best performance was recorded for 19 nm thick ZnO coating, possessing nearly 90% (bias voltage assisted) conversion of photons to electrons in the UV spectral range. In line with the results discussed above, the improved PEC performance of ZnO coated TNT layer was attributed to (i) advantageous TiO$_2$/ZnO heterojunction structure promoting charge generation and separation, (ii) surface passivation of surface traps of TNT layers, and (iii) reduced depletion width at electrolyte/ZnO interface as a result of UV light stimulated oxygen desorption [186] and applied bias voltage.

Sensing responses of ALD ZnO coated TNT layers towards ethanol at 200 °C are shown in Fig. 11b. The ZnO coating led to a significant response to 1930 ppm of ethanol. The best performance was observed for 19 nm thick ZnO coating. The sensing mechanism of ZnO coated TNT layers was explained by the surface depletion model [187]. Thus, in the initial high resistance state, the ZnO surface is depleted of electrons as a result of trapping of electrons by oxygen adsorbates. The drop of resistance upon exposure to ethanol was associated to an interaction between adsorbed oxygen species and ethanol leading to the release of oxygen-trapped electrons to the conduction band of ZnO.
ALD demonstrated to support realization of a functional gas sensor, based on the coating of aHAR nanostructures (TNT layers) acting as a sensor scaffold. ALD provides the possibility to boost the sensitivity of gas sensors by conformal deposition of functional secondary materials into high surface area TNT layers and the synergy of functional properties by fine tuning of the thickness of secondary material and its interface with the TNT layers. Moreover, in an analogous way to ref [188], the selectivity of ALD-TNT layers based gas sensor can be potentially tuned by deposition of multiple secondary materials. These can coat various depth levels of TNT layers as a result of sequential ALD process, employing various exposure times for control of the diffusion length of the particular precursors.

4.7 Energy storage

Besides the above mentioned applications, TiO$_2$ (anatase) is considered to be an interesting material for the negative electrode of Li-ion batteries thanks to its ability to insert Li ions
(TiO$_2$ inserts up to 0.5 Li$^+$ ions per structure unit), enhanced safety operation, low self-discharge, good capacity on retention, and high power density [189–192]. Utilization of nanostructured TiO$_2$, in particular anodic TNT layers, brings benefits of higher energy/power densities because of the higher surface area, shorter ion diffusion lengths between electrodes, improved electron transfer, and better accommodation of volumetric changes during the charge/discharge cycles [193–195]. The unique property of ALD to provide high-quality coating of nanostructured materials brings the opportunity to design complex electrodes for the best device performance. ALD can assist to develop a stable solid/electrolyte interface layer with high ionic conductivity and mechanical integrity [35,196–199].

The first application of ALD for modification of TNT layers for Li-ion batteries was reported by Li et al. [200], who coated TNT layers by ZnO (no details about the thickness of the coating or its uniformity were provided). ZnO is a material with high theoretical charge capacity (978 mAh/g) as compared to the charge capacity of TiO$_2$ (168 mA/h), but poor cycling ability because of high volumetric changes during charge-discharge cycles. However, as reproduced in Fig. 12a, the study showed that ZnO ALD coated TNT layers exhibit two times higher capacity than the bare counterparts and the overall performance of ALD ZnO coated TNTs layers was maintained upon 200 charge-discharge cycles. The improved performance was attributed to the synergy between the ALD ZnO coating, providing higher charge capacity and easier ion diffusion, and the TNT layers that accommodate volumetric changes during charge-discharge cycling.

Alternatively, Sopha et al. [201] inspected the effect of ALD Al$_2$O$_3$ coating of TNT layers on their performance as anode in Li-ion batteries. Al$_2$O$_3$ was deposited by the well-established ALD process used previously [118,181], leading to uniform coatings with thicknesses controlled on the atomic level (as discussed above), in this case ranging from 0.2 to 10 nm. The best charge capacity was observed for TNT layers coated by 1 nm thick Al$_2$O$_3$, while thicker coatings showed reduced capacity. The discharge capacity of 1 nm Al$_2$O$_3$ coated TNT layers (at 1 C rate) as a function of number of discharge cycles is shown in Fig. 12b. No mark of drop of charge capacity was observed through 100 discharge cycles. The enhanced charge capacity and the stability during charge/discharge cycling were attributed to (i) the better diffusion of Li$^+$ ions (through < 1 nm thick Al$_2$O$_3$ layer) as a result of the formation of a
surface Li-Al-O phase and (ii) the improved mechanical integrity of coated TNT layers (as demonstrated in [181]), leading to better accommodation of volumetric changes during cycling.

Figure 12: (a) Charge/discharge capacity of bare and ALD ZnO coated TNT layer as a function of charge/discharge cycles, reproduced from [200]. (b) Improved charge capacity of ALD Al₂O₃ coated TNT layer as compared with uncoated TNT layers throughout multiple charge/discharge cycles, reproduced from [201].

5. Conclusion

ALD represents an exceptional method for tailoring the functionality of nanostructured materials for various energy-related applications. The principal benefit of ALD over other techniques is its ability to provide conformal and uniform coatings of complex nanostructured materials, including HAR materials, with atomic scale thickness control and minimum amount of defects and pinholes. ALD enables the combination of materials within porous nanostructures with unequivocal precision. The utilization of ALD for coating of TNT
layers allows to extend the existing broad range of benefits of TNT layers to novel functionalities and applications of resulting heterostructures. Based on the herein reviewed reports, it is clear that the functionality of TNT layers can be completely altered already upon coating by secondary material with a thickness of only a few nanometers (or even less). In general, ALD coatings of TNT layers can significantly improve their chemical, mechanical, and thermal stability. A pathway to the competitive performance of TNT layer-based solar cells and photocatalysts can be paved away by ALD coatings of secondary materials for an efficient visible-light absorption, improved charge separation, and lowered charge recombination. Likewise, the catalytic properties of TNT layers can be advanced by ALD deposition of noble metal nanoparticles, leading to the formation of homogeneously distributed metal nanoparticles (strongly attached to TNT walls) with narrow particle size distribution. Regarding the application of TNT layers in gas sensors, ALD brings the opportunity to deposit functional secondary coatings with adjusted thickness for the best sensor sensitivity and selectivity. In energy storage applications of TNT layers, the ALD allows to deposit conformal coatings for improved ion transport and ion insertion properties and to design solid/electrolyte interface for long-term cycling stability.

The potential of ALD for functionalization of anodic TNT layers remains still relatively unexplored. For the future work, it is necessary to utilize a broader range of ALD compatible functional secondary materials and move towards the design of complex HAR heterostructures, seeking for emerging and new synergic properties.

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<tr>
<th>Abbreviation</th>
<th>Full Form</th>
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<tr>
<td>AAO</td>
<td>Anodic aluminium oxide</td>
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<tr>
<td>ALD</td>
<td>Atomic layer deposition</td>
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<tr>
<td>CBD</td>
<td>Chemical bath deposition</td>
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<tr>
<td>DSSC</td>
<td>Dye-sensitized solar cell</td>
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<tr>
<td>EDX</td>
<td>Energy-dispersive X-ray spectroscopy</td>
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<tr>
<td>EOR</td>
<td>Ethanol oxidation reaction</td>
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<tr>
<td>FTIR</td>
<td>Fourier transform infrared spectroscopy</td>
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<tr>
<td>HAADF</td>
<td>High-angle annular dark-field</td>
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<tr>
<td>(H)AR</td>
<td>(High) Aspect ratio</td>
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<tr>
<td>IPCE</td>
<td>Incident photon to electron conversion efficiency</td>
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<td>MB</td>
<td>Methylene blue</td>
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<td>MC</td>
<td>Monte Carlo</td>
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<tr>
<td>PEC</td>
<td>Photoelectrochemical</td>
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<td>QCM</td>
<td>Quartz crystal microbalance</td>
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<td>QD</td>
<td>Quantum dots</td>
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<td>SEM</td>
<td>Scanning electron microscope</td>
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<tr>
<td>SILAR</td>
<td>Successive ionic layer adsorption and reaction</td>
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<tr>
<td>(S)TEM</td>
<td>(Scanning) Transmission electron microscope</td>
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<tr>
<td>TMA</td>
<td>Trimethylaluminium</td>
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<tr>
<td>TNT</td>
<td>TiO$_2$ nanotube</td>
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<tr>
<td>UV</td>
<td>Ultraviolet spectral range</td>
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<tr>
<td>VIS</td>
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<tr>
<td>XRR</td>
<td>X-ray reflectivity</td>
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References:


doi:10.1021/cr900056b.


[129] H.K. Jun, M.A. Careem, A.K. Arof, Quantum dot-sensitized solar cells-perspective and recent developments: A review of Cd chalcogenide quantum dots as sensitizers,


